

ZMD31010

RBic_{Lite}TM Low-Cost Sensor Signal Conditioner

Technical Notes – Die Dimensions and Pad Coordinates

PRELIMINARY

ZMD31010 RBic_{Lite}TM Technical Notes Die Dimensions and Pad Coordinates

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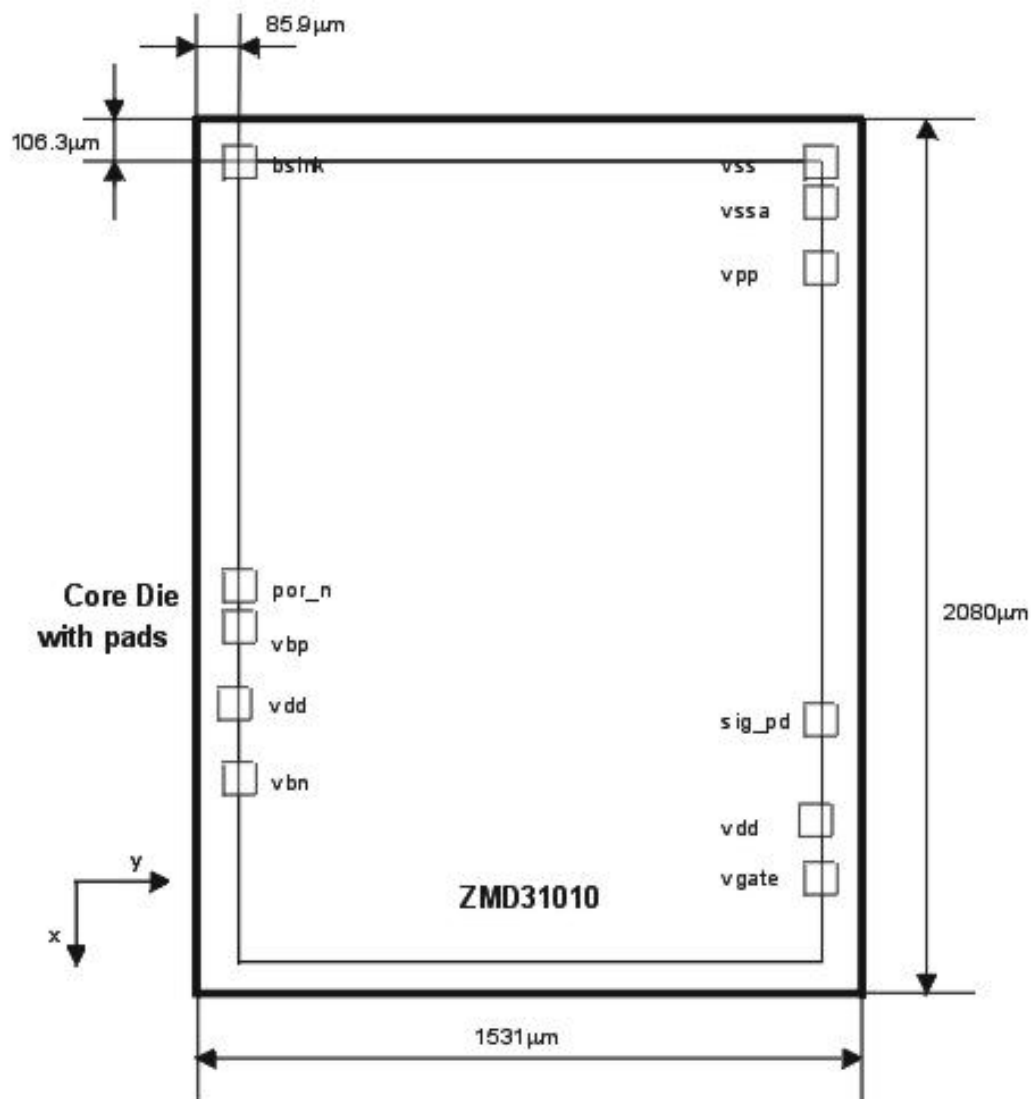
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1 RBic_{Lite}TM Die Dimensions

- Die size (including scribeline): 2230 μm x 1681 μm \approx 3.75sqmm
- Core die size (without scribeline): 2080 μm x 1531 μm \approx 3.19 sqmm
- Die thickness: 390 μm
- Scribeline (distance between two core dice on wafer): 150 μm
- Pads size: 68 μm x 68 μm



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2 RBic_{Lite}TM Pad Coordinates

All pads coordinates are for pad centers and related to the corner.

Name	X Coordinate in μ	Y Coordinate in μ
bsink	106.3	85.9
por_n	1109.7	85.9
vbp	1210.0	85.9
vdd	1389.3	77.3
vbn	1568.1	85.9
vss	107.2	1444.7
vssa	198.3	1444.7
vpp	356.1	1444.7
sig_pd	1428.6	1444.7
vdd	1672.3	1435.8
vgate	1809.2	1444.7

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3 Related Documents

- ZMD31010 RBic_{Lite}TM Datasheet
- ZMD31010 RBic_{Lite}TM Development Kit Documentation
- ZMD31010 RBic_{Lite}TM Errata Sheet
- ZMD31010 RBic_{Lite}TM Application Notes – In-Circuit Programming Boards

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For further information:

ZMD AG
Grenzstrasse 28
01109 Dresden, Germany
Phone +49 (0)351-8822-366
Fax +49 (0)351-8822-337
sales@zmd.de
www.zmd.biz

ZMD America, Inc.
201 Old Country Road, Suite 204
Melville, NY 11747, USA
Phone +01 (631) 549-2666
Fax +01 (631) 549-2882
sales@zmda.com
www.zmd.biz